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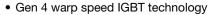
Vishay Semiconductors

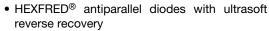
"Half Bridge" IGBT MTP (Warp Speed IGBT), 114 A



| PRODUCT SUMMARY | | | | | | |
|---|-------------------|--|--|--|--|--|
| V _{CES} | 600 V | | | | | |
| V _{CE(on)} typical at V _{GE} = 15 V | 2.3 V | | | | | |
| I _C at T _C = 25 °C | 114 A | | | | | |
| Speed | 30 kHz to 100 kHz | | | | | |
| Package | MTP | | | | | |
| Circuit | Half bridge | | | | | |

FEATURES







RoHS

- Very low conduction and switching losses
- Optional SMD thermistor (NTC)
- Very low junction to case thermal resistance
- UL approved file E78996
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Optimized for welding, UPS and SMPS applications
- · Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- · Very low stray inductance design for high speed operation

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|----------------------------------|-------------------|---------------------------------|------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | |
| Collector to emitter voltage | V _{CES} | | 600 | V | |
| Continuous collector current | | T _C = 25 °C | 114 | | |
| Continuous collector current | Ic | T _C = 109 °C | 50 | | |
| Pulsed collector current | I _{CM} | | 350 | A | |
| Peak switching current | I _{LM} | | 350 | | |
| Diode continuous forward current | I _F | T _C = 109 °C | 34 | | |
| Peak diode forward current | I _{FM} | | 200 | 1 | |
| Gate to emitter voltage | V _{GE} | | ± 20 | V | |
| RMS isolation voltage | V _{ISOL} | Any terminal to case, t = 1 min | 2500 |] v | |
| Maximum navvay disaination | В | T _C = 25 °C | 658 | W | |
| Maximum power dissipation | P_D | T _C = 100 °C | 263 |] vv | |





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| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | |
|--|----------------------|---|------|------|-------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage | V _{(BR)CES} | $V_{GE} = 0 \text{ V, } I_{C} = 500 \mu\text{A}$ | 600 | - | - | V |
| | | V _{GE} = 15 V, I _C = 50 A | - | 2.3 | 3.15 | v |
| Collector to emitter voltage | V _{CE(on)} | V _{GE} = 15 V, I _C = 100 A | - | 2.5 | 3.2 | |
| | | $V_{GE} = 15 \text{ V}, I_{C} = 50 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$ | - | 1.72 | 2.17 | V |
| Gate threshold voltage | V _{GE(th)} | $I_{C} = 0.5 \text{ mA}$ | 3 | ı | 6 | |
| Collector to emitter leaking current | I _{CES} | $V_{GE} = 0 \text{ V}, I_{C} = 600 \text{ A}$ | - | - | 0.4 | mA |
| | | $V_{GE} = 0 \text{ V}, I_{C} = 600 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$ | - | - | 10 | IIIA |
| Diode forward voltage drop | V _{FM} | $I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}$ | - | 1.58 | 1.80 | |
| | | I_F = 50 A, V_{GE} = 0 V, T_J = 150 °C | - | 1.49 | 1.68 | V |
| | | $I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 25 ^{\circ}\text{C}$ | - | 1.9 | 2.17 | |
| Gate to emitter leakage current | I _{GES} | V _{GE} = ± 20 V | - | - | ± 250 | nA |

| SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | |
|--|------------------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Total gate charge (turn-on) | Qg | I _C = 52 A | - | 331 | 385 | |
| Gate to emitter charge (turn-on) | Q _{ge} | V _{CC} = 400 V | - | 44 | 52 | nC |
| Gate to collector charge (turn-on) | Q _{gc} | V _{GE} = 15 V | - | 133 | 176 | |
| Turn-on switching loss | E _{on} | Internal gate resistors (see electrical diagram) | - | 0.26 | - | |
| Turn-off switching loss | E _{off} | $I_C = 50$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200 \mu H$ Energy losses include tail and diode reverse | - | 1.2 | - | mJ |
| Total switching loss | E _{ts} | recovery, T _J = 25 °C | - | 1.46 | - | |
| Turn-on switching loss | E _{on} | Internal gate resistors (see electrical diagram) I_C = 50 A, V_{CC} = 480 V, V_{GE} = 15 V, L = 200 μ H Energy losses include tail and diode reverse recovery, T_J = 150 °C | - | 0.73 | - | |
| Turn-off switching loss | E _{off} | | - | 1.66 | - | mJ |
| Total switching loss | E _{ts} | | - | 2.39 | - | |
| Input capacitance | C _{ies} | V _{GE} = 0 V V _{CC} = 30 V f = 1.0 MHz | - | 7100 | - | |
| Output capacitance | C _{oes} | | - | 510 | - | рF |
| Reverse transfer capacitance | C _{res} | | - | 140 | - | |
| Diode reverse recovery time | t _{rr} | | - | 82 | 97 | ns |
| Diode peak reverse current | I _{rr} | $V_{CC} = 200 \text{ V}, I_{C} = 50 \text{ A}$ dl/dt = 200 A/ μ s | - | 8.3 | 10.6 | Α |
| Diode recovery charge | Q _{rr} | | - | 340 | 514 | nC |
| Diode reverse recovery time | t _{rr} | V _{CC} = 200 V, I _C = 50 A dl/dt = 200 A/µs | - | 137 | 153 | ns |
| Diode peak reverse current | I _{rr} | | - | 12.7 | 14.8 | Α |
| Diode recovery charge | Q _{rr} | T _J = 125 °C | - | 870 | 1132 | nC |



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| THERMISTOR SPECIFICATIONS | | | | | | |
|--|-------------------------------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Resistance | R ₀ ⁽¹⁾ | T ₀ = 25 °C | - | 30 | - | kΩ |
| Sensitivity index of the thermistor material | β (1)(2) | T ₀ = 25 °C T ₁ = 85 °C | - | 4000 | - | К |

Notes

 $^{(1)}$ T₀, T₁ are thermistor's temperatures

(2)
$$\frac{R_0}{R_1} = exp \left[\beta \left(\frac{1}{T_0} - \frac{1}{T_1} \right) \right]$$
, temperature in Kelvin

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | |
|---------------------------------------|-------------------|--|----------|-------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Operating junction IGBT, Diode | T., | | -40 | - | 150 | |
| temperature range Thermistor | | | -40 | - | 125 | °C |
| Storage temperature range | T _{Stg} | | -40 | - | 125 | |
| Junction to case | В | | - | - | 0.38 | |
| Diode | R _{thJC} | | - | - 0.8 | 0.8 | °C/W |
| Case to sink per module | R _{thCS} | Heatsink compound thermal conductivity = 1 W/mK | - | 0.06 | - | |
| Clearance (1) | | External shortest distance in air between 2 terminals | 5.5 | - | - | |
| Creepage (1) | | Shortest distance along the external surface of the insulating material between 2 terminals | 8 | - | - | mm |
| Mounting torque to heatsink | | A mounting compound is recommended and the torque should be checked after 3 hours to allow for the spread of the compound. Lubricated threads. | 3 ± 10 % | | Nm | |
| Weight | | | | 66 | | g |

Note

⁽¹⁾ Standard version only i.e. without optional thermistor

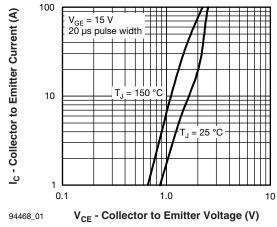


Fig. 1 - Typical Output Characteristics

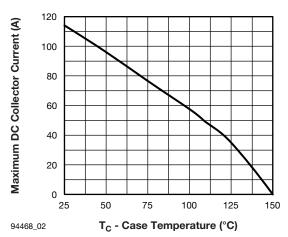


Fig. 2 - Maximum Collector Current vs. Case Temperature





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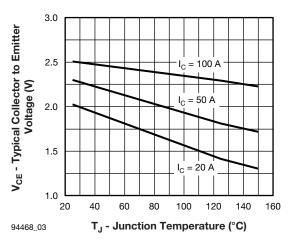


Fig. 3 - Typical Collector to Emitter Voltage vs. Junction Temperature

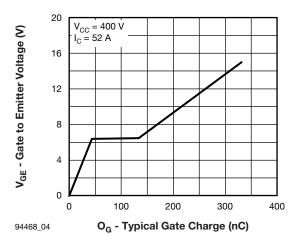


Fig. 4 - Typical Gate Charge vs. Gate to Emitter Votlage

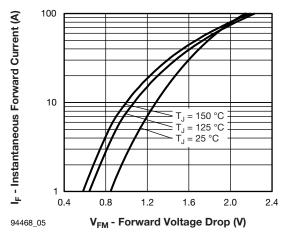


Fig. 5 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

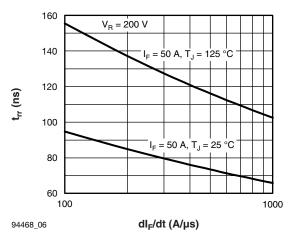


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt

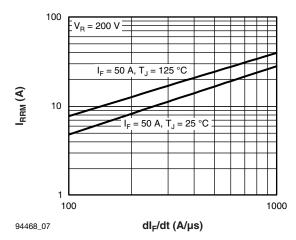


Fig. 7 - Typical Reverse Recovery Current vs. dl_F/dt

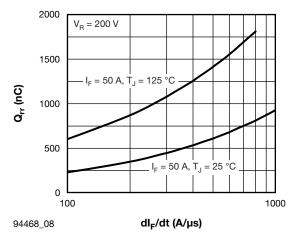
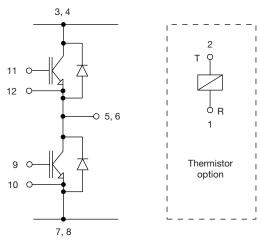


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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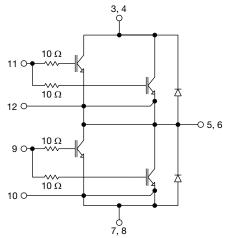
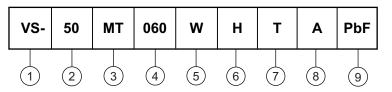


Fig. 10 - Electrical Diagram

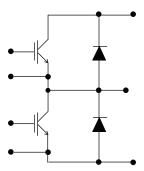
ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (50 = 50 A)
- 3 Essential part number
- 4 Voltage rating (060 = 600 V)
- 5 Speed/type (W = Warp IGBT)
- 6 Circuit configuration (H = Half bridge)
- 7 T = Thermistor
- 8 $A = Al_2O_3$ substrate
- 9 Lead (Pb)-free

CIRCUIT CONFIGURATION



| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95175 | | | |



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